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### Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

#### Details

|                                |                                                                                                                                     |
|--------------------------------|-------------------------------------------------------------------------------------------------------------------------------------|
| Product Status                 | Active                                                                                                                              |
| Number of LABs/CLBs            | 900                                                                                                                                 |
| Number of Logic Elements/Cells | 14400                                                                                                                               |
| Total RAM Bits                 | 552960                                                                                                                              |
| Number of I/O                  | 72                                                                                                                                  |
| Number of Gates                | -                                                                                                                                   |
| Voltage - Supply               | 1.16V ~ 1.24V                                                                                                                       |
| Mounting Type                  | Surface Mount                                                                                                                       |
| Operating Temperature          | 0°C ~ 85°C (TJ)                                                                                                                     |
| Package / Case                 | 169-LBGA                                                                                                                            |
| Supplier Device Package        | 169-FBGA (14x14)                                                                                                                    |
| Purchase URL                   | <a href="https://www.e-xfl.com/product-detail/intel/ep4cgx15bf14c6n">https://www.e-xfl.com/product-detail/intel/ep4cgx15bf14c6n</a> |

**Table 1–3. Recommended Operating Conditions for Cyclone IV E Devices <sup>(1), (2)</sup> (Part 2 of 2)**

| Symbol      | Parameter                                                  | Conditions | Min | Typ | Max | Unit |
|-------------|------------------------------------------------------------|------------|-----|-----|-----|------|
| $I_{Diode}$ | Magnitude of DC current across PCI-clamp diode when enable | —          | —   | —   | 10  | mA   |

**Notes to Table 1–3:**

- (1) Cyclone IV E 1.0 V core voltage devices only support C8L, C9L, and I8L speed grades. Cyclone IV E 1.2 V core voltage devices only support C6, C7, C8, I7, and A7 speed grades.
- (2)  $V_{CCIO}$  for all I/O banks must be powered up during device operation. All  $V_{CCA}$  pins must be powered to 2.5 V (even when PLLs are not used) and must be powered up and powered down at the same time.
- (3)  $V_{CC}$  must rise monotonically.
- (4)  $V_{CCIO}$  powers all input buffers.
- (5) The POR time for Standard POR ranges between 50 and 200 ms. Each individual power supply must reach the recommended operating range within 50 ms.
- (6) The POR time for Fast POR ranges between 3 and 9 ms. Each individual power supply must reach the recommended operating range within 3 ms.

**Table 1–4. Recommended Operating Conditions for Cyclone IV GX Devices (Part 1 of 2)**

| Symbol                          | Parameter                                                          | Conditions | Min   | Typ | Max   | Unit |
|---------------------------------|--------------------------------------------------------------------|------------|-------|-----|-------|------|
| $V_{CCINT}^{(3)}$               | Core voltage, PCIe hard IP block, and transceiver PCS power supply | —          | 1.16  | 1.2 | 1.24  | V    |
| $V_{CCA}^{(1), (3)}$            | PLL analog power supply                                            | —          | 2.375 | 2.5 | 2.625 | V    |
| $V_{CCD\_PLL}^{(2)}$            | PLL digital power supply                                           | —          | 1.16  | 1.2 | 1.24  | V    |
| $V_{CCIO}^{(3), (4)}$           | I/O banks power supply for 3.3-V operation                         | —          | 3.135 | 3.3 | 3.465 | V    |
|                                 | I/O banks power supply for 3.0-V operation                         | —          | 2.85  | 3   | 3.15  | V    |
|                                 | I/O banks power supply for 2.5-V operation                         | —          | 2.375 | 2.5 | 2.625 | V    |
|                                 | I/O banks power supply for 1.8-V operation                         | —          | 1.71  | 1.8 | 1.89  | V    |
|                                 | I/O banks power supply for 1.5-V operation                         | —          | 1.425 | 1.5 | 1.575 | V    |
|                                 | I/O banks power supply for 1.2-V operation                         | —          | 1.14  | 1.2 | 1.26  | V    |
| $V_{CC\_CLKIN}^{(3), (5), (6)}$ | Differential clock input pins power supply for 3.3-V operation     | —          | 3.135 | 3.3 | 3.465 | V    |
|                                 | Differential clock input pins power supply for 3.0-V operation     | —          | 2.85  | 3   | 3.15  | V    |
|                                 | Differential clock input pins power supply for 2.5-V operation     | —          | 2.375 | 2.5 | 2.625 | V    |
|                                 | Differential clock input pins power supply for 1.8-V operation     | —          | 1.71  | 1.8 | 1.89  | V    |
|                                 | Differential clock input pins power supply for 1.5-V operation     | —          | 1.425 | 1.5 | 1.575 | V    |
|                                 | Differential clock input pins power supply for 1.2-V operation     | —          | 1.14  | 1.2 | 1.26  | V    |
| $V_{CCH\_GXB}$                  | Transceiver output buffer power supply                             | —          | 2.375 | 2.5 | 2.625 | V    |

**Table 1-4. Recommended Operating Conditions for Cyclone IV GX Devices (Part 2 of 2)**

| Symbol         | Parameter                                                   | Conditions                                   | Min        | Typ | Max        | Unit |
|----------------|-------------------------------------------------------------|----------------------------------------------|------------|-----|------------|------|
| $V_{CCA\_GXB}$ | Transceiver PMA and auxiliary power supply                  | —                                            | 2.375      | 2.5 | 2.625      | V    |
| $V_{CCL\_GXB}$ | Transceiver PMA and auxiliary power supply                  | —                                            | 1.16       | 1.2 | 1.24       | V    |
| $V_I$          | DC input voltage                                            | —                                            | -0.5       | —   | 3.6        | V    |
| $V_O$          | DC output voltage                                           | —                                            | 0          | —   | $V_{CCIO}$ | V    |
| $T_J$          | Operating junction temperature                              | For commercial use                           | 0          | —   | 85         | °C   |
|                |                                                             | For industrial use                           | -40        | —   | 100        | °C   |
| $t_{RAMP}$     | Power supply ramp time                                      | Standard power-on reset (POR) <sup>(7)</sup> | 50 $\mu$ s | —   | 50 ms      | —    |
|                |                                                             | Fast POR <sup>(8)</sup>                      | 50 $\mu$ s | —   | 3 ms       | —    |
| $I_{Diode}$    | Magnitude of DC current across PCI-clamp diode when enabled | —                                            | —          | —   | 10         | mA   |

**Notes to Table 1-4:**

- (1) All  $V_{CCA}$  pins must be powered to 2.5 V (even when PLLs are not used) and must be powered up and powered down at the same time.
- (2) You must connect  $V_{CCD\_PLL}$  to  $V_{CCINT}$  through a decoupling capacitor and ferrite bead.
- (3) Power supplies must rise monotonically.
- (4)  $V_{CCIO}$  for all I/O banks must be powered up during device operation. Configurations pins are powered up by  $V_{CCIO}$  of I/O Banks 3, 8, and 9 where I/O Banks 3 and 9 only support  $V_{CCIO}$  of 1.5, 1.8, 2.5, 3.0, and 3.3 V. For fast passive parallel (FPP) configuration mode, the  $V_{CCIO}$  level of I/O Bank 8 must be powered up to 1.5, 1.8, 2.5, 3.0, and 3.3 V.
- (5) You must set  $V_{CC\_CLKIN}$  to 2.5 V if you use  $CLKIN$  as a high-speed serial interface (HSSI)  $refclk$  or as a  $DIFFCLK$  input.
- (6) The  $CLKIN$  pins in I/O Banks 3B and 8B can support single-ended I/O standard when the pins are used to clock left PLLs in non-transceiver applications.
- (7) The POR time for Standard POR ranges between 50 and 200 ms.  $V_{CCINT}$ ,  $V_{CCA}$ , and  $V_{CCIO}$  of I/O Banks 3, 8, and 9 must reach the recommended operating range within 50 ms.
- (8) The POR time for Fast POR ranges between 3 and 9 ms.  $V_{CCINT}$ ,  $V_{CCA}$ , and  $V_{CCIO}$  of I/O Banks 3, 8, and 9 must reach the recommended operating range within 3 ms.

## ESD Performance

This section lists the electrostatic discharge (ESD) voltages using the human body model (HBM) and charged device model (CDM) for Cyclone IV devices general purpose I/Os (GPIOs) and high-speed serial interface (HSSI) I/Os. Table 1-5 lists the ESD for Cyclone IV devices GPIOs and HSSI I/Os.

**Table 1-5. ESD for Cyclone IV Devices GPIOs and HSSI I/Os**

| Symbol       | Parameter                                        | Passing Voltage | Unit |
|--------------|--------------------------------------------------|-----------------|------|
| $V_{ESDHBM}$ | ESD voltage using the HBM (GPIOs) <sup>(1)</sup> | $\pm 2000$      | V    |
|              | ESD using the HBM (HSSI I/Os) <sup>(2)</sup>     | $\pm 1000$      | V    |
| $V_{ESDCDM}$ | ESD using the CDM (GPIOs)                        | $\pm 500$       | V    |
|              | ESD using the CDM (HSSI I/Os) <sup>(2)</sup>     | $\pm 250$       | V    |

**Notes to Table 1-5:**

- (1) The passing voltage for EP4CGX15 and EP4CGX30 row I/Os is  $\pm 1000$ V.
- (2) This value is applicable only to Cyclone IV GX devices.

**Table 1–7. Bus Hold Parameter for Cyclone IV Devices (Part 2 of 2) <sup>(1)</sup>**

| Parameter           | Condition | V <sub>CCIO</sub> (V) |     |       |       |      |      |     |     |     |     |     |     | Unit |
|---------------------|-----------|-----------------------|-----|-------|-------|------|------|-----|-----|-----|-----|-----|-----|------|
|                     |           | 1.2                   |     | 1.5   |       | 1.8  |      | 2.5 |     | 3.0 |     | 3.3 |     |      |
|                     |           | Min                   | Max | Min   | Max   | Min  | Max  | Min | Max | Min | Max | Min | Max |      |
| Bus hold trip point | —         | 0.3                   | 0.9 | 0.375 | 1.125 | 0.68 | 1.07 | 0.7 | 1.7 | 0.8 | 2   | 0.8 | 2   | V    |

**Note to Table 1–7:**

(1) Bus hold trip points are based on the calculated input voltages from the JEDEC standard.

## OCT Specifications

Table 1–8 lists the variation of OCT without calibration across process, temperature, and voltage (PVT).

**Table 1–8. Series OCT Without Calibration Specifications for Cyclone IV Devices**

| Description                    | $V_{CCIO}$ (V) | Resistance Tolerance |                                                         | Unit |
|--------------------------------|----------------|----------------------|---------------------------------------------------------|------|
|                                |                | Commercial Maximum   | Industrial, Extended industrial, and Automotive Maximum |      |
| Series OCT without calibration | 3.0            | ±30                  | ±40                                                     | %    |
|                                | 2.5            | ±30                  | ±40                                                     | %    |
|                                | 1.8            | ±40                  | ±50                                                     | %    |
|                                | 1.5            | ±50                  | ±50                                                     | %    |
|                                | 1.2            | ±50                  | ±50                                                     | %    |

OCT calibration is automatically performed at device power-up for OCT-enabled I/Os.

Table 1–9 lists the OCT calibration accuracy at device power-up.

**Table 1–9. Series OCT with Calibration at Device Power-Up Specifications for Cyclone IV Devices**

| Description                                    | $V_{CCIO}$ (V) | Calibration Accuracy |                                                         | Unit |
|------------------------------------------------|----------------|----------------------|---------------------------------------------------------|------|
|                                                |                | Commercial Maximum   | Industrial, Extended industrial, and Automotive Maximum |      |
| Series OCT with calibration at device power-up | 3.0            | ±10                  | ±10                                                     | %    |
|                                                | 2.5            | ±10                  | ±10                                                     | %    |
|                                                | 1.8            | ±10                  | ±10                                                     | %    |
|                                                | 1.5            | ±10                  | ±10                                                     | %    |
|                                                | 1.2            | ±10                  | ±10                                                     | %    |

Example 1–1 shows how to calculate the change of 50-Ω I/O impedance from 25°C at 3.0 V to 85°C at 3.15 V.

#### Example 1–1. Impedance Change

$$\Delta R_V = (3.15 - 3) \times 1000 \times -0.026 = -3.83$$

$$\Delta R_T = (85 - 25) \times 0.262 = 15.72$$

Because  $\Delta R_V$  is negative,

$$MF_V = 1 / (3.83/100 + 1) = 0.963$$

Because  $\Delta R_T$  is positive,

$$MF_T = 15.72/100 + 1 = 1.157$$

$$MF = 0.963 \times 1.157 = 1.114$$

$$R_{\text{final}} = 50 \times 1.114 = 55.71 \, \Omega$$

## Pin Capacitance

Table 1–11 lists the pin capacitance for Cyclone IV devices.

**Table 1–11. Pin Capacitance for Cyclone IV Devices <sup>(1)</sup>**

| Symbol                     | Parameter                                                                                                           | Typical –<br>Quad Flat<br>Pack<br>(QFP) | Typical –<br>Quad Flat<br>No Leads<br>(QFN) | Typical –<br>Ball-Grid<br>Array<br>(BGA) | Unit |
|----------------------------|---------------------------------------------------------------------------------------------------------------------|-----------------------------------------|---------------------------------------------|------------------------------------------|------|
| C <sub>IOTB</sub>          | Input capacitance on top and bottom I/O pins                                                                        | 7                                       | 7                                           | 6                                        | pF   |
| C <sub>IOLR</sub>          | Input capacitance on right I/O pins                                                                                 | 7                                       | 7                                           | 5                                        | pF   |
| C <sub>LVDSLR</sub>        | Input capacitance on right I/O pins with dedicated LVDS output                                                      | 8                                       | 8                                           | 7                                        | pF   |
| C <sub>VREFLR</sub><br>(2) | Input capacitance on right dual-purpose V <sub>REF</sub> pin when used as V <sub>REF</sub> or user I/O pin          | 21                                      | 21                                          | 21                                       | pF   |
| C <sub>VREFTB</sub><br>(2) | Input capacitance on top and bottom dual-purpose V <sub>REF</sub> pin when used as V <sub>REF</sub> or user I/O pin | 23 (3)                                  | 23                                          | 23                                       | pF   |
| C <sub>CLKTB</sub>         | Input capacitance on top and bottom dedicated clock input pins                                                      | 7                                       | 7                                           | 6                                        | pF   |
| C <sub>CLKLR</sub>         | Input capacitance on right dedicated clock input pins                                                               | 6                                       | 6                                           | 5                                        | pF   |

#### Notes to Table 1–11:

- (1) The pin capacitance applies to FBGA, UBGA, and MBGA packages.
- (2) When you use the V<sub>REF</sub> pin as a regular input or output, you can expect a reduced performance of toggle rate and t<sub>CO</sub> because of higher pin capacitance.
- (3) C<sub>VREFTB</sub> for the EP4CE22 device is 30 pF.

**Table 1–20. Differential I/O Standard Specifications for Cyclone IV Devices <sup>(1)</sup> (Part 2 of 2)**

| I/O Standard                                | V <sub>CCIO</sub> (V) |     |       | V <sub>ID</sub> (mV) |     | V <sub>ICM</sub> (V) <sup>(2)</sup> |                                                       |      | V <sub>OD</sub> (mV) <sup>(3)</sup> |     |     | V <sub>OS</sub> (V) <sup>(3)</sup> |      |       |
|---------------------------------------------|-----------------------|-----|-------|----------------------|-----|-------------------------------------|-------------------------------------------------------|------|-------------------------------------|-----|-----|------------------------------------|------|-------|
|                                             | Min                   | Typ | Max   | Min                  | Max | Min                                 | Condition                                             | Max  | Min                                 | Typ | Max | Min                                | Typ  | Max   |
| LVDS<br>(Column I/Os)                       | 2.375                 | 2.5 | 2.625 | 100                  | —   | 0.05                                | $D_{MAX} \leq 500 \text{ Mbps}$                       | 1.80 | 247                                 | —   | 600 | 1.125                              | 1.25 | 1.375 |
|                                             |                       |     |       |                      |     | 0.55                                | $500 \text{ Mbps} \leq D_{MAX} \leq 700 \text{ Mbps}$ | 1.80 |                                     |     |     |                                    |      |       |
|                                             |                       |     |       |                      |     | 1.05                                | $D_{MAX} > 700 \text{ Mbps}$                          | 1.55 |                                     |     |     |                                    |      |       |
| BLVDS (Row I/Os) <sup>(4)</sup>             | 2.375                 | 2.5 | 2.625 | 100                  | —   | —                                   | —                                                     | —    | —                                   | —   | —   | —                                  | —    | —     |
| BLVDS (Column I/Os) <sup>(4)</sup>          | 2.375                 | 2.5 | 2.625 | 100                  | —   | —                                   | —                                                     | —    | —                                   | —   | —   | —                                  | —    | —     |
| mini-LVDS (Row I/Os) <sup>(5)</sup>         | 2.375                 | 2.5 | 2.625 | —                    | —   | —                                   | —                                                     | —    | 300                                 | —   | 600 | 1.0                                | 1.2  | 1.4   |
| mini-LVDS (Column I/Os) <sup>(5)</sup>      | 2.375                 | 2.5 | 2.625 | —                    | —   | —                                   | —                                                     | —    | 300                                 | —   | 600 | 1.0                                | 1.2  | 1.4   |
| RSDS <sup>®</sup> (Row I/Os) <sup>(5)</sup> | 2.375                 | 2.5 | 2.625 | —                    | —   | —                                   | —                                                     | —    | 100                                 | 200 | 600 | 0.5                                | 1.2  | 1.5   |
| RSDS (Column I/Os) <sup>(5)</sup>           | 2.375                 | 2.5 | 2.625 | —                    | —   | —                                   | —                                                     | —    | 100                                 | 200 | 600 | 0.5                                | 1.2  | 1.5   |
| PPDS (Row I/Os) <sup>(5)</sup>              | 2.375                 | 2.5 | 2.625 | —                    | —   | —                                   | —                                                     | —    | 100                                 | 200 | 600 | 0.5                                | 1.2  | 1.4   |
| PPDS (Column I/Os) <sup>(5)</sup>           | 2.375                 | 2.5 | 2.625 | —                    | —   | —                                   | —                                                     | —    | 100                                 | 200 | 600 | 0.5                                | 1.2  | 1.4   |

**Notes to Table 1–20:**

- (1) For an explanation of terms used in Table 1–20, refer to “Glossary” on page 1–37.
- (2) V<sub>IN</sub> range:  $0 \text{ V} \leq V_{IN} \leq 1.85 \text{ V}$ .
- (3) R<sub>L</sub> range:  $90 \leq R_L \leq 110 \Omega$ .
- (4) There are no fixed V<sub>IN</sub>, V<sub>OD</sub>, and V<sub>OS</sub> specifications for BLVDS. They depend on the system topology.
- (5) The Mini-LVDS, RSDS, and PPDS standards are only supported at the output pins.
- (6) The LVPECL I/O standard is only supported on dedicated clock input pins. This I/O standard is not supported for output pins.

## Transceiver Performance Specifications

Table 1-21 lists the Cyclone IV GX transceiver specifications.

**Table 1-21. Transceiver Specification for Cyclone IV GX Devices (Part 1 of 4)**

| Symbol/<br>Description                           | Conditions                                                          | C6                      |            |        | C7, I7                  |            |        | C8                      |            |        | Unit   |
|--------------------------------------------------|---------------------------------------------------------------------|-------------------------|------------|--------|-------------------------|------------|--------|-------------------------|------------|--------|--------|
|                                                  |                                                                     | Min                     | Typ        | Max    | Min                     | Typ        | Max    | Min                     | Typ        | Max    |        |
| Reference Clock                                  |                                                                     |                         |            |        |                         |            |        |                         |            |        |        |
| Supported I/O Standards                          | 1.2 V PCML, 1.5 V PCML, 3.3 V PCML, Differential LVPECL, LVDS, HCSL |                         |            |        |                         |            |        |                         |            |        |        |
| Input frequency from REFCLK input pins           | —                                                                   | 50                      | —          | 156.25 | 50                      | —          | 156.25 | 50                      | —          | 156.25 | MHz    |
| Spread-spectrum modulating clock frequency       | Physical interface for PCI Express (PIPE) mode                      | 30                      | —          | 33     | 30                      | —          | 33     | 30                      | —          | 33     | kHz    |
| Spread-spectrum downspread                       | PIPE mode                                                           | —                       | 0 to –0.5% | —      | —                       | 0 to –0.5% | —      | —                       | 0 to –0.5% | —      | —      |
| Peak-to-peak differential input voltage          | —                                                                   | 0.1                     | —          | 1.6    | 0.1                     | —          | 1.6    | 0.1                     | —          | 1.6    | V      |
| V <sub>ICM</sub> (AC coupled)                    | —                                                                   | 1100 ± 5%               |            |        | 1100 ± 5%               |            |        | 1100 ± 5%               |            |        | mV     |
| V <sub>ICM</sub> (DC coupled)                    | HCSL I/O standard for PCIe reference clock                          | 250                     | —          | 550    | 250                     | —          | 550    | 250                     | —          | 550    | mV     |
| Transmitter REFCLK Phase Noise <sup>(1)</sup>    | Frequency offset = 1 MHz – 8 MHz                                    | —                       | —          | –123   | —                       | —          | –123   | —                       | —          | –123   | dBc/Hz |
| Transmitter REFCLK Total Jitter <sup>(1)</sup>   |                                                                     | —                       | —          | 42.3   | —                       | —          | 42.3   | —                       | —          | 42.3   | ps     |
| R <sub>ref</sub>                                 | —                                                                   | —                       | 2000 ± 1%  | —      | —                       | 2000 ± 1%  | —      | —                       | 2000 ± 1%  | —      | Ω      |
| Transceiver Clock                                |                                                                     |                         |            |        |                         |            |        |                         |            |        |        |
| cal_blk_clk clock frequency                      | —                                                                   | 10                      | —          | 125    | 10                      | —          | 125    | 10                      | —          | 125    | MHz    |
| fixedclk clock frequency                         | PCIe Receiver Detect                                                | —                       | 125        | —      | —                       | 125        | —      | —                       | 125        | —      | MHz    |
| reconfig_clk clock frequency                     | Dynamic reconfiguration clock frequency                             | 2.5/37.5 <sup>(2)</sup> | —          | 50     | 2.5/37.5 <sup>(2)</sup> | —          | 50     | 2.5/37.5 <sup>(2)</sup> | —          | 50     | MHz    |
| Delta time between reconfig_clk                  | —                                                                   | —                       | —          | 2      | —                       | —          | 2      | —                       | —          | 2      | ms     |
| Transceiver block minimum power-down pulse width | —                                                                   | —                       | 1          | —      | —                       | 1          | —      | —                       | 1          | —      | μs     |

Table 1–21. Transceiver Specification for Cyclone IV GX Devices (Part 2 of 4)

| Symbol/<br>Description                                                               | Conditions                                                            | C6                              |           |                                                   | C7, I7 |           |                                                   | C8   |           |                                                   | Unit |
|--------------------------------------------------------------------------------------|-----------------------------------------------------------------------|---------------------------------|-----------|---------------------------------------------------|--------|-----------|---------------------------------------------------|------|-----------|---------------------------------------------------|------|
|                                                                                      |                                                                       | Min                             | Typ       | Max                                               | Min    | Typ       | Max                                               | Min  | Typ       | Max                                               |      |
| Receiver                                                                             |                                                                       |                                 |           |                                                   |        |           |                                                   |      |           |                                                   |      |
| Supported I/O Standards                                                              | 1.4 V PCML,<br>1.5 V PCML,<br>2.5 V PCML,<br>LVPECL, LVDS             |                                 |           |                                                   |        |           |                                                   |      |           |                                                   |      |
| Data rate (F324 and smaller package) <sup>(15)</sup>                                 | —                                                                     | 600                             | —         | 2500                                              | 600    | —         | 2500                                              | 600  | —         | 2500                                              | Mbps |
| Data rate (F484 and larger package) <sup>(15)</sup>                                  | —                                                                     | 600                             | —         | 3125                                              | 600    | —         | 3125                                              | 600  | —         | 2500                                              | Mbps |
| Absolute V <sub>MAX</sub> for a receiver pin <sup>(3)</sup>                          | —                                                                     | —                               | —         | 1.6                                               | —      | —         | 1.6                                               | —    | —         | 1.6                                               | V    |
| Operational V <sub>MAX</sub> for a receiver pin                                      | —                                                                     | —                               | —         | 1.5                                               | —      | —         | 1.5                                               | —    | —         | 1.5                                               | V    |
| Absolute V <sub>MIN</sub> for a receiver pin                                         | —                                                                     | –0.4                            | —         | —                                                 | –0.4   | —         | —                                                 | –0.4 | —         | —                                                 | V    |
| Peak-to-peak differential input voltage V <sub>ID</sub> (diff p-p)                   | V <sub>ICM</sub> = 0.82 V setting, Data Rate = 600 Mbps to 3.125 Gbps | 0.1                             | —         | 2.7                                               | 0.1    | —         | 2.7                                               | 0.1  | —         | 2.7                                               | V    |
| V <sub>ICM</sub>                                                                     | V <sub>ICM</sub> = 0.82 V setting                                     | —                               | 820 ± 10% | —                                                 | —      | 820 ± 10% | —                                                 | —    | 820 ± 10% | —                                                 | mV   |
| Differential on-chip termination resistors                                           | 100–Ω setting                                                         | —                               | 100       | —                                                 | —      | 100       | —                                                 | —    | 100       | —                                                 | Ω    |
|                                                                                      | 150–Ω setting                                                         | —                               | 150       | —                                                 | —      | 150       | —                                                 | —    | 150       | —                                                 | Ω    |
| Differential and common mode return loss                                             | PIPE, Serial Rapid I/O SR, SATA, CPRI LV, SDI, XAUI                   | Compliant                       |           |                                                   |        |           |                                                   |      |           |                                                   | —    |
| Programmable ppm detector <sup>(4)</sup>                                             | —                                                                     | ± 62.5, 100, 125, 200, 250, 300 |           |                                                   |        |           |                                                   |      |           |                                                   | ppm  |
| Clock data recovery (CDR) ppm tolerance (without spread-spectrum clocking enabled)   | —                                                                     | —                               | —         | ±300 <sup>(5)</sup> ,<br>±350 <sup>(6), (7)</sup> | —      | —         | ±300 <sup>(5)</sup> ,<br>±350 <sup>(6), (7)</sup> | —    | —         | ±300 <sup>(5)</sup> ,<br>±350 <sup>(6), (7)</sup> | ppm  |
| CDR ppm tolerance (with synchronous spread-spectrum clocking enabled) <sup>(8)</sup> | —                                                                     | —                               | —         | 350 to –5350 <sup>(7), (9)</sup>                  | —      | —         | 350 to –5350 <sup>(7), (9)</sup>                  | —    | —         | 350 to –5350 <sup>(7), (9)</sup>                  | ppm  |
| Run length                                                                           | —                                                                     | —                               | 80        | —                                                 | —      | 80        | —                                                 | —    | 80        | —                                                 | UI   |
| Programmable equalization                                                            | No Equalization                                                       | —                               | —         | 1.5                                               | —      | —         | 1.5                                               | —    | —         | 1.5                                               | dB   |
|                                                                                      | Medium Low                                                            | —                               | —         | 4.5                                               | —      | —         | 4.5                                               | —    | —         | 4.5                                               | dB   |
|                                                                                      | Medium High                                                           | —                               | —         | 5.5                                               | —      | —         | 5.5                                               | —    | —         | 5.5                                               | dB   |
|                                                                                      | High                                                                  | —                               | —         | 7                                                 | —      | —         | 7                                                 | —    | —         | 7                                                 | dB   |




**Table 1–21. Transceiver Specification for Cyclone IV GX Devices (Part 4 of 4)**

| Symbol/<br>Description                           | Conditions | C6                                 |     |        | C7, I7 |     |        | C8  |     |        | Unit |
|--------------------------------------------------|------------|------------------------------------|-----|--------|--------|-----|--------|-----|-----|--------|------|
|                                                  |            | Min                                | Typ | Max    | Min    | Typ | Max    | Min | Typ | Max    |      |
| PLD-Transceiver Interface                        |            |                                    |     |        |        |     |        |     |     |        |      |
| Interface speed<br>(F324 and smaller<br>package) | —          | 25                                 | —   | 125    | 25     | —   | 125    | 25  | —   | 125    | MHz  |
| Interface speed<br>(F484 and larger<br>package)  | —          | 25                                 | —   | 156.25 | 25     | —   | 156.25 | 25  | —   | 156.25 | MHz  |
| Digital reset pulse<br>width                     | —          | Minimum is 2 parallel clock cycles |     |        |        |     |        |     |     |        |      |

**Notes to Table 1–21:**

- (1) This specification is valid for transmitter output jitter specification with a maximum total jitter value of 112 ps, typically for 3.125 Gbps SRIO and XAUI protocols.
- (2) The minimum `reconfig_clk` frequency is 2.5 MHz if the transceiver channel is configured in **Transmitter Only** mode. The minimum `reconfig_clk` frequency is 37.5 MHz if the transceiver channel is configured in **Receiver Only** or **Receiver and Transmitter** mode.
- (3) The device cannot tolerate prolonged operation at this absolute maximum.
- (4) The rate matcher supports only up to  $\pm 300$  parts per million (ppm).
- (5) Supported for the F169 and F324 device packages only.
- (6) Supported for the F484, F672, and F896 device packages only. Pending device characterization.
- (7) To support CDR ppm tolerance greater than  $\pm 300$  ppm, implement ppm detector in user logic and configure CDR to Manual Lock Mode.
- (8) Asynchronous spread-spectrum clocking is not supported.
- (9) For the EP4CGX30 (F484 package only), EP4CGX50, and EP4CGX75 devices, the CDR ppl tolerance is  $\pm 200$  ppm.
- (10) Time taken until `p11_locked` goes high after `p11_powerdown` deasserts.
- (11) Time that the CDR must be kept in lock-to-reference mode after `rx_analogreset` deasserts and before `rx_locktodata` is asserted in manual mode.
- (12) Time taken to recover valid data after the `rx_locktodata` signal is asserted in manual mode (Figure 1–2), or after `rx_freqlocked` signal goes high in automatic mode (Figure 1–3).
- (13) Time taken to recover valid data after the `rx_locktodata` signal is asserted in manual mode.
- (14) Time taken to recover valid data after the `rx_freqlocked` signal goes high in automatic mode.
- (15) To support data rates lower than the minimum specification through oversampling, use the CDR in LTR mode only.

Figure 1-2 shows the lock time parameters in manual mode.

 LTD = lock-to-data. LTR = lock-to-reference.

**Figure 1-2. Lock Time Parameters for Manual Mode**

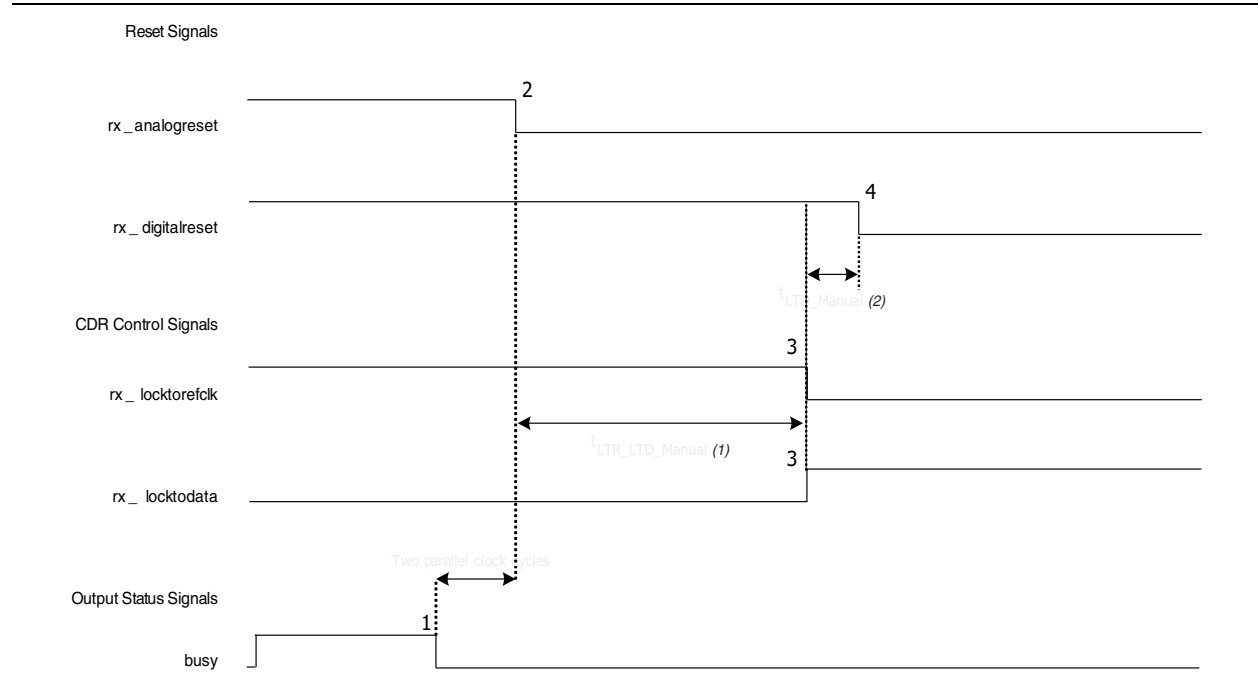


Figure 1-3 shows the lock time parameters in automatic mode.

**Figure 1-3. Lock Time Parameters for Automatic Mode**

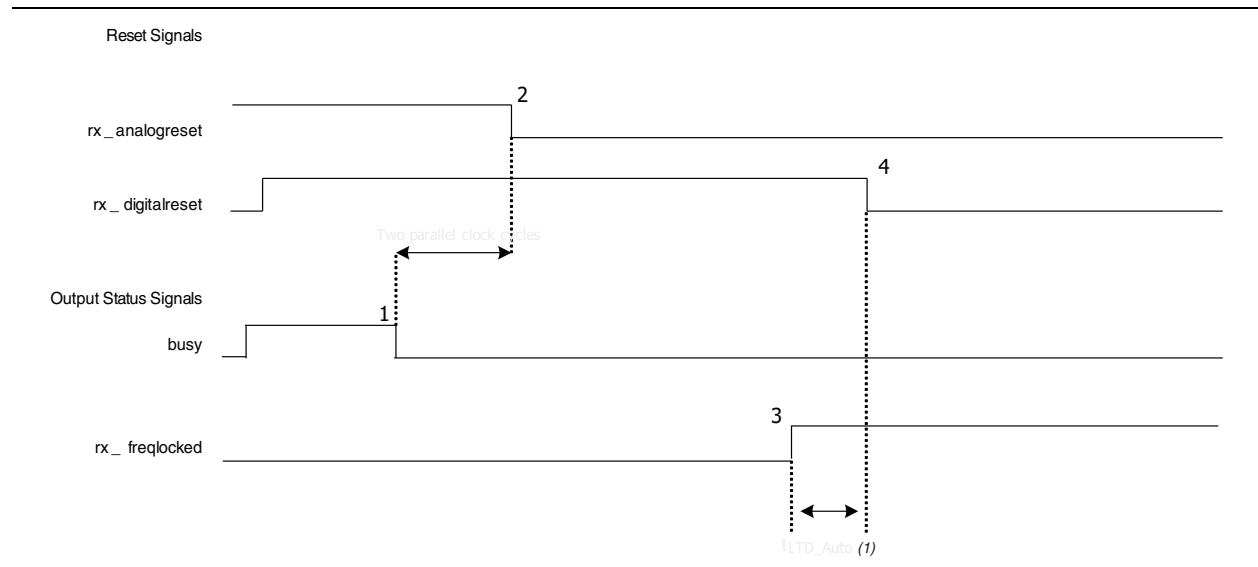


Figure 1-4 shows the differential receiver input waveform.

**Figure 1-4. Receiver Input Waveform**

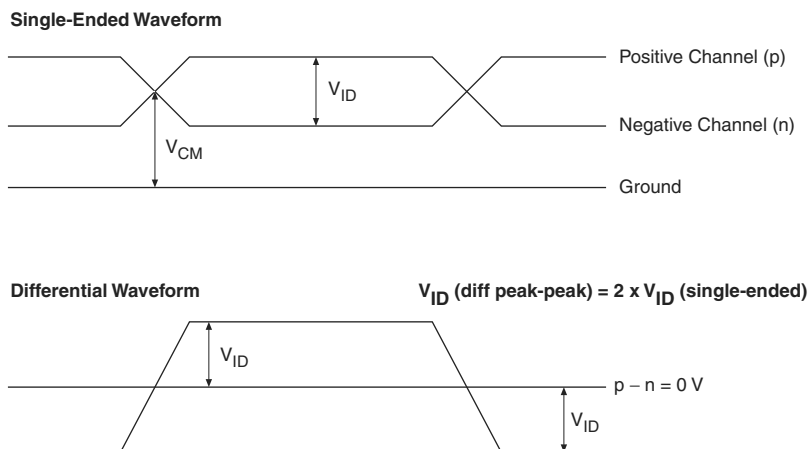


Figure 1-5 shows the transmitter output waveform.

**Figure 1-5. Transmitter Output Waveform**

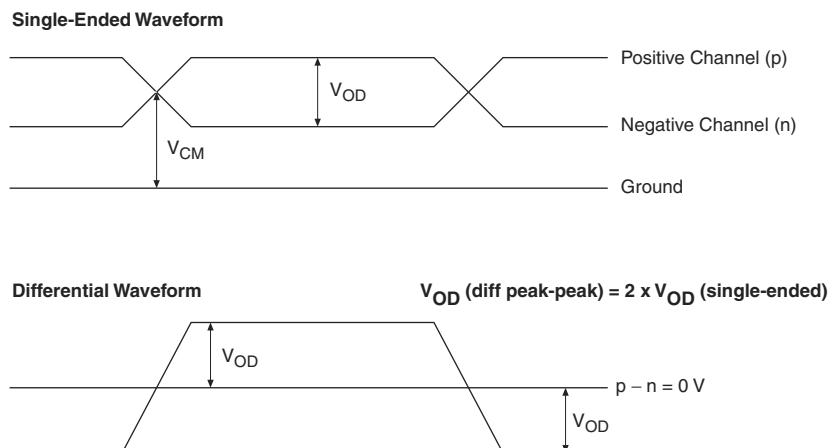


Table 1-22 lists the typical  $V_{OD}$  for Tx term that equals 100  $\Omega$ .

**Table 1-22. Typical  $V_{OD}$  Setting, Tx Term = 100  $\Omega$**

| Symbol                                          | $V_{OD}$ Setting (mV) |     |     |       |      |      |
|-------------------------------------------------|-----------------------|-----|-----|-------|------|------|
|                                                 | 1                     | 2   | 3   | 4 (1) | 5    | 6    |
| $V_{OD}$ differential peak to peak typical (mV) | 400                   | 600 | 800 | 900   | 1000 | 1200 |

**Note to Table 1-22:**

(1) This setting is required for compliance with the PCIe protocol.

Table 1–23 lists the Cyclone IV GX transceiver block AC specifications.

**Table 1–23. Transceiver Block AC Specification for Cyclone IV GX Devices <sup>(1), (2)</sup>**

| Symbol/<br>Description                                            | Conditions         | C6     |     |       | C7, I7 |     |       | C8     |     |       | Unit |
|-------------------------------------------------------------------|--------------------|--------|-----|-------|--------|-----|-------|--------|-----|-------|------|
|                                                                   |                    | Min    | Typ | Max   | Min    | Typ | Max   | Min    | Typ | Max   |      |
| PCIe Transmit Jitter Generation <sup>(3)</sup>                    |                    |        |     |       |        |     |       |        |     |       |      |
| Total jitter at 2.5 Gbps (Gen1)                                   | Compliance pattern | —      | —   | 0.25  | —      | —   | 0.25  | —      | —   | 0.25  | UI   |
| PCIe Receiver Jitter Tolerance <sup>(3)</sup>                     |                    |        |     |       |        |     |       |        |     |       |      |
| Total jitter at 2.5 Gbps (Gen1)                                   | Compliance pattern | > 0.6  |     |       | > 0.6  |     |       | > 0.6  |     |       | UI   |
| GIGE Transmit Jitter Generation <sup>(4)</sup>                    |                    |        |     |       |        |     |       |        |     |       |      |
| Deterministic jitter (peak-to-peak)                               | Pattern = CRPAT    | —      | —   | 0.14  | —      | —   | 0.14  | —      | —   | 0.14  | UI   |
| Total jitter (peak-to-peak)                                       | Pattern = CRPAT    | —      | —   | 0.279 | —      | —   | 0.279 | —      | —   | 0.279 | UI   |
| GIGE Receiver Jitter Tolerance <sup>(4)</sup>                     |                    |        |     |       |        |     |       |        |     |       |      |
| Deterministic jitter tolerance (peak-to-peak)                     | Pattern = CJPAT    | > 0.4  |     |       | > 0.4  |     |       | > 0.4  |     |       | UI   |
| Combined deterministic and random jitter tolerance (peak-to-peak) | Pattern = CJPAT    | > 0.66 |     |       | > 0.66 |     |       | > 0.66 |     |       | UI   |

**Notes to Table 1–23:**

- (1) Dedicated `refclk` pins were used to drive the input reference clocks.
- (2) The jitter numbers specified are valid for the stated conditions only.
- (3) The jitter numbers for PIPE are compliant to the PCIe Base Specification 2.0.
- (4) The jitter numbers for GIGE are compliant to the IEEE802.3-2002 Specification.

## Core Performance Specifications

The following sections describe the clock tree specifications, PLLs, embedded multiplier, memory block, and configuration specifications for Cyclone IV Devices.

### Clock Tree Specifications

Table 1–24 lists the clock tree specifications for Cyclone IV devices.

**Table 1–24. Clock Tree Performance for Cyclone IV Devices (Part 1 of 2)**

| Device  | Performance |       |     |                    |                    |       |                    |     | Unit |
|---------|-------------|-------|-----|--------------------|--------------------|-------|--------------------|-----|------|
|         | C6          | C7    | C8  | C8L <sup>(1)</sup> | C9L <sup>(1)</sup> | I7    | I8L <sup>(1)</sup> | A7  |      |
| EP4CE6  | 500         | 437.5 | 402 | 362                | 265                | 437.5 | 362                | 402 | MHz  |
| EP4CE10 | 500         | 437.5 | 402 | 362                | 265                | 437.5 | 362                | 402 | MHz  |
| EP4CE15 | 500         | 437.5 | 402 | 362                | 265                | 437.5 | 362                | 402 | MHz  |
| EP4CE22 | 500         | 437.5 | 402 | 362                | 265                | 437.5 | 362                | 402 | MHz  |
| EP4CE30 | 500         | 437.5 | 402 | 362                | 265                | 437.5 | 362                | 402 | MHz  |
| EP4CE40 | 500         | 437.5 | 402 | 362                | 265                | 437.5 | 362                | 402 | MHz  |

**Table 1-31. RSDS Transmitter Timing Specifications for Cyclone IV Devices <sup>(1), (2), (4)</sup> (Part 2 of 2)**

| Symbol                           | Modes | C6  |     |     | C7, I7 |     |     | C8, A7 |     |     | C8L, I8L |     |     | C9L |     |     | Unit |
|----------------------------------|-------|-----|-----|-----|--------|-----|-----|--------|-----|-----|----------|-----|-----|-----|-----|-----|------|
|                                  |       | Min | Typ | Max | Min    | Typ | Max | Min    | Typ | Max | Min      | Typ | Max | Min | Typ | Max |      |
| t <sub>LOCK</sub> <sup>(3)</sup> | —     | —   | —   | 1   | —      | —   | 1   | —      | —   | 1   | —        | —   | 1   | —   | —   | 1   | ms   |

**Notes to Table 1-31:**

- (1) Applicable for true RSDS and emulated RSDS\_E\_3R transmitter.
- (2) Cyclone IV E devices—true RSDS transmitter is only supported at the output pin of Row I/O Banks 1, 2, 5, and 6. Emulated RSDS transmitter is supported at the output pin of all I/O Banks.  
Cyclone IV GX devices—true RSDS transmitter is only supported at the output pin of Row I/O Banks 5 and 6. Emulated RSDS transmitter is supported at the output pin of I/O Banks 3, 4, 5, 6, 7, 8, and 9.
- (3) t<sub>LOCK</sub> is the time required for the PLL to lock from the end-of-device configuration.
- (4) Cyclone IV E 1.0 V core voltage devices only support C8L, C9L, and I8L speed grades. Cyclone IV E 1.2 V core voltage devices only support C6, C7, C8, I7, and A7 speed grades. Cyclone IV GX devices only support C6, C7, C8, and I7 speed grades.

**Table 1-32. Emulated RSDS\_E\_1R Transmitter Timing Specifications for Cyclone IV Devices <sup>(1), (3)</sup> (Part 1 of 2)**

| Symbol                                    | Modes                                 | C6  |     |     | C7, I7 |     |     | C8, A7 |     |     | C8L, I8L |     |     | C9L |     |      | Unit |
|-------------------------------------------|---------------------------------------|-----|-----|-----|--------|-----|-----|--------|-----|-----|----------|-----|-----|-----|-----|------|------|
|                                           |                                       | Min | Typ | Max | Min    | Typ | Max | Min    | Typ | Max | Min      | Typ | Max | Min | Typ | Max  |      |
| f <sub>HCLK</sub> (input clock frequency) | ×10                                   | 5   | —   | 85  | 5      | —   | 85  | 5      | —   | 85  | 5        | —   | 85  | 5   | —   | 72.5 | MHz  |
|                                           | ×8                                    | 5   | —   | 85  | 5      | —   | 85  | 5      | —   | 85  | 5        | —   | 85  | 5   | —   | 72.5 | MHz  |
|                                           | ×7                                    | 5   | —   | 85  | 5      | —   | 85  | 5      | —   | 85  | 5        | —   | 85  | 5   | —   | 72.5 | MHz  |
|                                           | ×4                                    | 5   | —   | 85  | 5      | —   | 85  | 5      | —   | 85  | 5        | —   | 85  | 5   | —   | 72.5 | MHz  |
|                                           | ×2                                    | 5   | —   | 85  | 5      | —   | 85  | 5      | —   | 85  | 5        | —   | 85  | 5   | —   | 72.5 | MHz  |
|                                           | ×1                                    | 5   | —   | 170 | 5      | —   | 170 | 5      | —   | 170 | 5        | —   | 170 | 5   | —   | 145  | MHz  |
| Device operation in Mbps                  | ×10                                   | 100 | —   | 170 | 100    | —   | 170 | 100    | —   | 170 | 100      | —   | 170 | 100 | —   | 145  | Mbps |
|                                           | ×8                                    | 80  | —   | 170 | 80     | —   | 170 | 80     | —   | 170 | 80       | —   | 170 | 80  | —   | 145  | Mbps |
|                                           | ×7                                    | 70  | —   | 170 | 70     | —   | 170 | 70     | —   | 170 | 70       | —   | 170 | 70  | —   | 145  | Mbps |
|                                           | ×4                                    | 40  | —   | 170 | 40     | —   | 170 | 40     | —   | 170 | 40       | —   | 170 | 40  | —   | 145  | Mbps |
|                                           | ×2                                    | 20  | —   | 170 | 20     | —   | 170 | 20     | —   | 170 | 20       | —   | 170 | 20  | —   | 145  | Mbps |
|                                           | ×1                                    | 10  | —   | 170 | 10     | —   | 170 | 10     | —   | 170 | 10       | —   | 170 | 10  | —   | 145  | Mbps |
| t <sub>DUTY</sub>                         | —                                     | 45  | —   | 55  | 45     | —   | 55  | 45     | —   | 55  | 45       | —   | 55  | 45  | —   | 55   | %    |
| TCCS                                      | —                                     | —   | —   | 200 | —      | —   | 200 | —      | —   | 200 | —        | —   | 200 | —   | —   | 200  | ps   |
| Output jitter (peak to peak)              | —                                     | —   | —   | 500 | —      | —   | 500 | —      | —   | 550 | —        | —   | 600 | —   | —   | 700  | ps   |
| t <sub>RISE</sub>                         | 20 – 80%,<br>C <sub>LOAD</sub> = 5 pF | —   | 500 | —   | —      | 500 | —   | —      | 500 | —   | —        | 500 | —   | —   | 500 | —    | ps   |
| t <sub>FALL</sub>                         | 20 – 80%,<br>C <sub>LOAD</sub> = 5 pF | —   | 500 | —   | —      | 500 | —   | —      | 500 | —   | —        | 500 | —   | —   | 500 | —    | ps   |

For more information about the supported maximum clock rate, device and pin planning, IP implementation, and device termination, refer to *Section III: System Performance Specifications* of the *External Memory Interface Handbook*.

Table 1–37 lists the memory output clock jitter specifications for Cyclone IV devices.

**Table 1–37. Memory Output Clock Jitter Specifications for Cyclone IV Devices <sup>(1), (2)</sup>**

| Parameter                    | Symbol          | Min  | Max | Unit |
|------------------------------|-----------------|------|-----|------|
| Clock period jitter          | $t_{JIT(per)}$  | –125 | 125 | ps   |
| Cycle-to-cycle period jitter | $t_{JIT(cc)}$   | –200 | 200 | ps   |
| Duty cycle jitter            | $t_{JIT(duty)}$ | –150 | 150 | ps   |

**Notes to Table 1–37:**

- (1) Memory output clock jitter measurements are for 200 consecutive clock cycles, as specified in the JEDEC DDR2 standard.
- (2) The clock jitter specification applies to memory output clock pins generated using DDIO circuits clocked by a PLL output routed on a global clock (GCLK) network.

## Duty Cycle Distortion Specifications

Table 1–38 lists the worst case duty cycle distortion for Cyclone IV devices.

**Table 1–38. Duty Cycle Distortion on Cyclone IV Devices I/O Pins <sup>(1), (2), (3)</sup>**

| Symbol            | C6  |     | C7, I7 |     | C8, I8L, A7 |     | C9L |     | Unit |
|-------------------|-----|-----|--------|-----|-------------|-----|-----|-----|------|
|                   | Min | Max | Min    | Max | Min         | Max | Min | Max |      |
| Output Duty Cycle | 45  | 55  | 45     | 55  | 45          | 55  | 45  | 55  | %    |

**Notes to Table 1–38:**

- (1) The duty cycle distortion specification applies to clock outputs from the PLLs, global clock tree, and IOE driving the dedicated and general purpose I/O pins.
- (2) Cyclone IV devices meet the specified duty cycle distortion at the maximum output toggle rate for each combination of I/O standard and current strength.
- (3) Cyclone IV E 1.0 V core voltage devices only support C8L, C9L, and I8L speed grades. Cyclone IV E 1.2 V core voltage devices only support C6, C7, C8, I7, and A7 speed grades. Cyclone IV GX devices only support C6, C7, C8, and I7 speed grades.

## OCT Calibration Timing Specification

Table 1–39 lists the duration of calibration for series OCT with calibration at device power-up for Cyclone IV devices.

**Table 1–39. Timing Specification for Series OCT with Calibration at Device Power-Up for Cyclone IV Devices <sup>(1)</sup>**

| Symbol       | Description                                                | Maximum | Units   |
|--------------|------------------------------------------------------------|---------|---------|
| $t_{OCTCAL}$ | Duration of series OCT with calibration at device power-up | 20      | $\mu$ s |

**Note to Table 1–39:**

- (1) OCT calibration takes place after device configuration and before entering user mode.

## IOE Programmable Delay

Table 1–40 and Table 1–41 list the IOE programmable delay for Cyclone IV E 1.0 V core voltage devices.

**Table 1–40. IOE Programmable Delay on Column Pins for Cyclone IV E 1.0 V Core Voltage Devices <sup>(1), (2)</sup>**

| Parameter                                                       | Paths Affected              | Number of Setting | Min Offset | Max Offset  |       |             |       |       | Unit |
|-----------------------------------------------------------------|-----------------------------|-------------------|------------|-------------|-------|-------------|-------|-------|------|
|                                                                 |                             |                   |            | Fast Corner |       | Slow Corner |       |       |      |
|                                                                 |                             |                   |            | C8L         | I8L   | C8L         | C9L   | I8L   |      |
| Input delay from pin to internal cells                          | Pad to I/O dataout to core  | 7                 | 0          | 2.054       | 1.924 | 3.387       | 4.017 | 3.411 | ns   |
| Input delay from pin to input register                          | Pad to I/O input register   | 8                 | 0          | 2.010       | 1.875 | 3.341       | 4.252 | 3.367 | ns   |
| Delay from output register to output pin                        | I/O output register to pad  | 2                 | 0          | 0.641       | 0.631 | 1.111       | 1.377 | 1.124 | ns   |
| Input delay from dual-purpose clock pin to fan-out destinations | Pad to global clock network | 12                | 0          | 0.971       | 0.931 | 1.684       | 2.298 | 1.684 | ns   |

**Notes to Table 1–40:**

- (1) The incremental values for the settings are generally linear. For the exact values for each setting, use the latest version of the Quartus II software.
- (2) The minimum and maximum offset timing numbers are in reference to setting **0** as available in the Quartus II software.

**Table 1–41. IOE Programmable Delay on Row Pins for Cyclone IV E 1.0 V Core Voltage Devices <sup>(1), (2)</sup>**

| Parameter                                                       | Paths Affected              | Number of Setting | Min Offset | Max Offset  |       |             |       |       | Unit |
|-----------------------------------------------------------------|-----------------------------|-------------------|------------|-------------|-------|-------------|-------|-------|------|
|                                                                 |                             |                   |            | Fast Corner |       | Slow Corner |       |       |      |
|                                                                 |                             |                   |            | C8L         | I8L   | C8L         | C9L   | I8L   |      |
| Input delay from pin to internal cells                          | Pad to I/O dataout to core  | 7                 | 0          | 2.057       | 1.921 | 3.389       | 4.146 | 3.412 | ns   |
| Input delay from pin to input register                          | Pad to I/O input register   | 8                 | 0          | 2.059       | 1.919 | 3.420       | 4.374 | 3.441 | ns   |
| Delay from output register to output pin                        | I/O output register to pad  | 2                 | 0          | 0.670       | 0.623 | 1.160       | 1.420 | 1.168 | ns   |
| Input delay from dual-purpose clock pin to fan-out destinations | Pad to global clock network | 12                | 0          | 0.960       | 0.919 | 1.656       | 2.258 | 1.656 | ns   |

**Notes to Table 1–41:**

- (1) The incremental values for the settings are generally linear. For the exact values for each setting, use the latest version of the Quartus II software.
- (2) The minimum and maximum offset timing numbers are in reference to setting **0** as available in the Quartus II software.

Table 1–42 and Table 1–43 list the IOE programmable delay for Cyclone IV E 1.2 V core voltage devices.

**Table 1–42. IOE Programmable Delay on Column Pins for Cyclone IV E 1.2 V Core Voltage Devices <sup>(1), (2)</sup>**

| Parameter                                                       | Paths Affected              | Number of Setting | Min Offset | Max Offset  |       |       |             |       |       |       |       | Unit |
|-----------------------------------------------------------------|-----------------------------|-------------------|------------|-------------|-------|-------|-------------|-------|-------|-------|-------|------|
|                                                                 |                             |                   |            | Fast Corner |       |       | Slow Corner |       |       |       |       |      |
|                                                                 |                             |                   |            | C6          | I7    | A7    | C6          | C7    | C8    | I7    | A7    |      |
| Input delay from pin to internal cells                          | Pad to I/O dataout to core  | 7                 | 0          | 1.314       | 1.211 | 1.211 | 2.177       | 2.340 | 2.433 | 2.388 | 2.508 | ns   |
| Input delay from pin to input register                          | Pad to I/O input register   | 8                 | 0          | 1.307       | 1.203 | 1.203 | 2.19        | 2.387 | 2.540 | 2.430 | 2.545 | ns   |
| Delay from output register to output pin                        | I/O output register to pad  | 2                 | 0          | 0.437       | 0.402 | 0.402 | 0.747       | 0.820 | 0.880 | 0.834 | 0.873 | ns   |
| Input delay from dual-purpose clock pin to fan-out destinations | Pad to global clock network | 12                | 0          | 0.693       | 0.665 | 0.665 | 1.200       | 1.379 | 1.532 | 1.393 | 1.441 | ns   |

**Notes to Table 1–42:**

- (1) The incremental values for the settings are generally linear. For the exact values for each setting, use the latest version of the Quartus II software.
- (2) The minimum and maximum offset timing numbers are in reference to setting **0** as available in the Quartus II software.

**Table 1–43. IOE Programmable Delay on Row Pins for Cyclone IV E 1.2 V Core Voltage Devices <sup>(1), (2)</sup>**

| Parameter                                                       | Paths Affected              | Number of Setting | Min Offset | Max Offset  |       |       |             |       |       |       |       | Unit |
|-----------------------------------------------------------------|-----------------------------|-------------------|------------|-------------|-------|-------|-------------|-------|-------|-------|-------|------|
|                                                                 |                             |                   |            | Fast Corner |       |       | Slow Corner |       |       |       |       |      |
|                                                                 |                             |                   |            | C6          | I7    | A7    | C6          | C7    | C8    | I7    | A7    |      |
| Input delay from pin to internal cells                          | Pad to I/O dataout to core  | 7                 | 0          | 1.314       | 1.209 | 1.209 | 2.201       | 2.386 | 2.510 | 2.429 | 2.548 | ns   |
| Input delay from pin to input register                          | Pad to I/O input register   | 8                 | 0          | 1.312       | 1.207 | 1.207 | 2.202       | 2.402 | 2.558 | 2.447 | 2.557 | ns   |
| Delay from output register to output pin                        | I/O output register to pad  | 2                 | 0          | 0.458       | 0.419 | 0.419 | 0.783       | 0.861 | 0.924 | 0.875 | 0.915 | ns   |
| Input delay from dual-purpose clock pin to fan-out destinations | Pad to global clock network | 12                | 0          | 0.686       | 0.657 | 0.657 | 1.185       | 1.360 | 1.506 | 1.376 | 1.422 | ns   |

**Notes to Table 1–43:**

- (1) The incremental values for the settings are generally linear. For the exact values for each setting, use the latest version of the Quartus II software.
- (2) The minimum and maximum offset timing numbers are in reference to setting **0** as available in the Quartus II software.



Table 1-46. Glossary (Part 3 of 5)

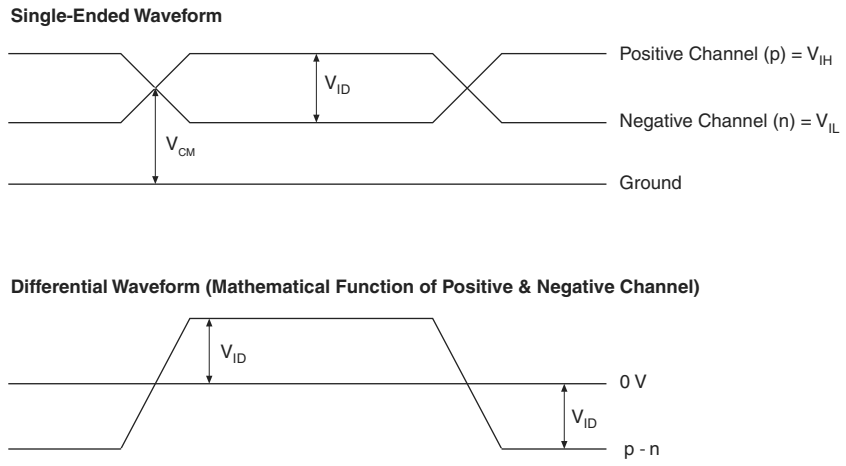
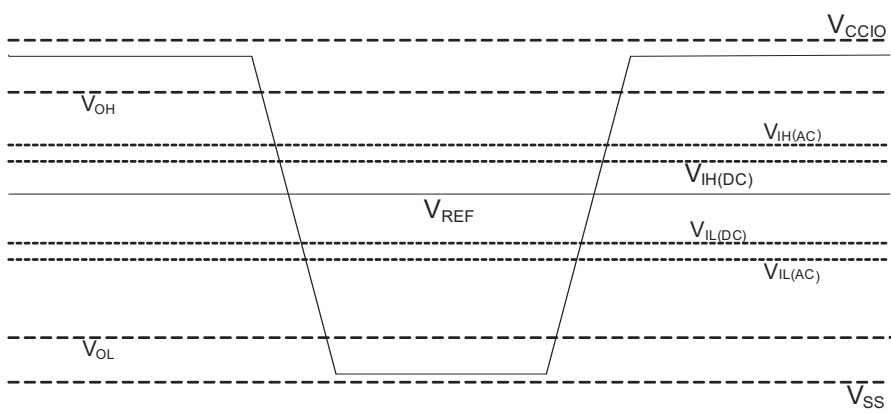
| Letter | Term                                         | Definitions                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |
|--------|----------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| R      | $R_L$                                        | Receiver differential input discrete resistor (external to Cyclone IV devices).                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
|        | Receiver Input Waveform                      | <p>Receiver input waveform for LVDS and LVPECL differential standards:</p>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
|        | Receiver input skew margin (RSKM)            | High-speed I/O block: The total margin left after accounting for the sampling window and TCCS. $RSKM = (TUI - SW - TCCS) / 2$ .                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
| S      | Single-ended voltage-referenced I/O Standard |  <p>The JEDEC standard for SSTI and HSTL I/O standards defines both the AC and DC input signal values. The AC values indicate the voltage levels at which the receiver must meet its timing specifications. The DC values indicate the voltage levels at which the final logic state of the receiver is unambiguously defined. After the receiver input crosses the AC value, the receiver changes to the new logic state. The new logic state is then maintained as long as the input stays beyond the DC threshold. This approach is intended to provide predictable receiver timing in the presence of input waveform <i>ringing</i>.</p> |
|        | SW (Sampling Window)                         | High-speed I/O block: The period of time during which the data must be valid to capture it correctly. The setup and hold times determine the ideal strobe position in the sampling window.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |

Table 1-46. Glossary (Part 4 of 5)

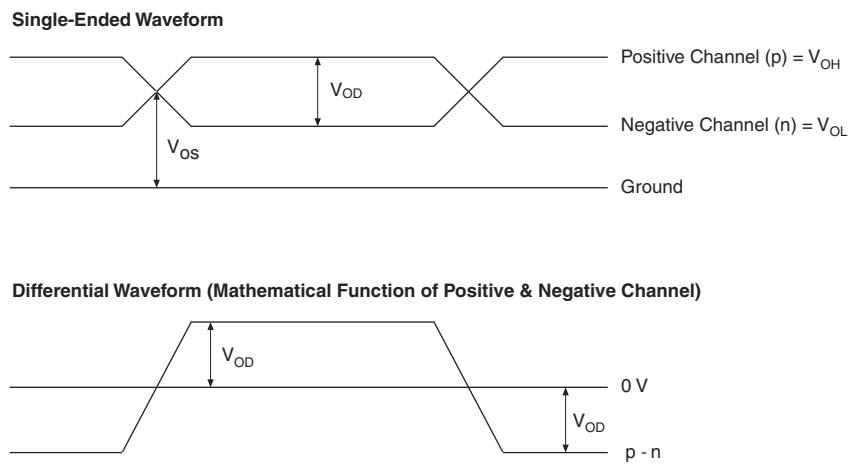
| Letter | Term                           | Definitions                                                                                                                                                                                 |
|--------|--------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| T      | $t_C$                          | High-speed receiver and transmitter input and output clock period.                                                                                                                          |
|        | Channel-to-channel-skew (TCCS) | High-speed I/O block: The timing difference between the fastest and slowest output edges, including $t_{CO}$ variation and clock skew. The clock is included in the TCCS measurement.       |
|        | $t_{cin}$                      | Delay from the clock pad to the I/O input register.                                                                                                                                         |
|        | $t_{CO}$                       | Delay from the clock pad to the I/O output.                                                                                                                                                 |
|        | $t_{cout}$                     | Delay from the clock pad to the I/O output register.                                                                                                                                        |
|        | $t_{DUTY}$                     | High-speed I/O block: Duty cycle on high-speed transmitter output clock.                                                                                                                    |
|        | $t_{FALL}$                     | Signal high-to-low transition time (80–20%).                                                                                                                                                |
|        | $t_H$                          | Input register hold time.                                                                                                                                                                   |
|        | Timing Unit Interval (TUI)     | High-speed I/O block: The timing budget allowed for skew, propagation delays, and data sampling window. (TUI = $1/(\text{Receiver Input Clock Frequency Multiplication Factor}) = t_C/w$ ). |
|        | $t_{INJITTER}$                 | Period jitter on the PLL clock input.                                                                                                                                                       |
|        | $t_{OUTJITTER\_DEDCLK}$        | Period jitter on the dedicated clock output driven by a PLL.                                                                                                                                |
|        | $t_{OUTJITTER\_IO}$            | Period jitter on the general purpose I/O driven by a PLL.                                                                                                                                   |
|        | $t_{pllcin}$                   | Delay from the PLL inclk pad to the I/O input register.                                                                                                                                     |
|        | $t_{pllcout}$                  | Delay from the PLL inclk pad to the I/O output register.                                                                                                                                    |
|        | Transmitter Output Waveform    | <p>Transmitter output waveforms for the LVDS, mini-LVDS, PPDS and RSDS Differential I/O Standards:</p>  |
|        | $t_{RISE}$                     | Signal low-to-high transition time (20–80%).                                                                                                                                                |
|        | $t_{SU}$                       | Input register setup time.                                                                                                                                                                  |
| U      | —                              | —                                                                                                                                                                                           |

Table 1-46. Glossary (Part 5 of 5)

| Letter   | Term            | Definitions                                                                                                                                                                                    |
|----------|-----------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| <b>V</b> | $V_{CM(DC)}$    | DC common mode input voltage.                                                                                                                                                                  |
|          | $V_{DIF(AC)}$   | AC differential input voltage: The minimum AC input differential voltage required for switching.                                                                                               |
|          | $V_{DIF(DC)}$   | DC differential input voltage: The minimum DC input differential voltage required for switching.                                                                                               |
|          | $V_{ICM}$       | Input common mode voltage: The common mode of the differential signal at the receiver.                                                                                                         |
|          | $V_{ID}$        | Input differential voltage swing: The difference in voltage between the positive and complementary conductors of a differential transmission at the receiver.                                  |
|          | $V_{IH}$        | Voltage input high: The minimum positive voltage applied to the input that is accepted by the device as a logic high.                                                                          |
|          | $V_{IH(AC)}$    | High-level AC input voltage.                                                                                                                                                                   |
|          | $V_{IH(DC)}$    | High-level DC input voltage.                                                                                                                                                                   |
|          | $V_{IL}$        | Voltage input low: The maximum positive voltage applied to the input that is accepted by the device as a logic low.                                                                            |
|          | $V_{IL(AC)}$    | Low-level AC input voltage.                                                                                                                                                                    |
|          | $V_{IL(DC)}$    | Low-level DC input voltage.                                                                                                                                                                    |
|          | $V_{IN}$        | DC input voltage.                                                                                                                                                                              |
|          | $V_{OCM}$       | Output common mode voltage: The common mode of the differential signal at the transmitter.                                                                                                     |
|          | $V_{OD}$        | Output differential voltage swing: The difference in voltage between the positive and complementary conductors of a differential transmission at the transmitter. $V_{OD} = V_{OH} - V_{OL}$ . |
|          | $V_{OH}$        | Voltage output high: The maximum positive voltage from an output that the device considers is accepted as the minimum positive high level.                                                     |
|          | $V_{OL}$        | Voltage output low: The maximum positive voltage from an output that the device considers is accepted as the maximum positive low level.                                                       |
|          | $V_{OS}$        | Output offset voltage: $V_{OS} = (V_{OH} + V_{OL}) / 2$ .                                                                                                                                      |
|          | $V_{OX(AC)}$    | AC differential output cross point voltage: the voltage at which the differential output signals must cross.                                                                                   |
|          | $V_{REF}$       | Reference voltage for the SSTL and HSTL I/O standards.                                                                                                                                         |
|          | $V_{REF(AC)}$   | AC input reference voltage for the SSTL and HSTL I/O standards. $V_{REF(AC)} = V_{REF(DC)} + \text{noise}$ . The peak-to-peak AC noise on $V_{REF}$ must not exceed 2% of $V_{REF(DC)}$ .      |
|          | $V_{REF(DC)}$   | DC input reference voltage for the SSTL and HSTL I/O standards.                                                                                                                                |
|          | $V_{SWING(AC)}$ | AC differential input voltage: AC input differential voltage required for switching. For the SSTL differential I/O standard, refer to Input Waveforms.                                         |
|          | $V_{SWING(DC)}$ | DC differential input voltage: DC input differential voltage required for switching. For the SSTL differential I/O standard, refer to Input Waveforms.                                         |
|          | $V_{TT}$        | Termination voltage for the SSTL and HSTL I/O standards.                                                                                                                                       |
|          | $V_X(AC)$       | AC differential input cross point voltage: The voltage at which the differential input signals must cross.                                                                                     |
| <b>W</b> | —               | —                                                                                                                                                                                              |
| <b>X</b> | —               | —                                                                                                                                                                                              |
| <b>Y</b> | —               | —                                                                                                                                                                                              |
| <b>Z</b> | —               | —                                                                                                                                                                                              |

## Document Revision History

Table 1–47 lists the revision history for this chapter.

**Table 1–47. Document Revision History**

| Date          | Version | Changes                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
|---------------|---------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| March 2016    | 2.0     | Updated note (5) in Table 1–21 to remove support for the N148 package.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
| October 2014  | 1.9     | Updated maximum value for $V_{CCD\_PLL}$ in Table 1–1.<br>Removed extended temperature note in Table 1–3.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
| December 2013 | 1.8     | Updated Table 1–21 by adding Note (15).                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
| May 2013      | 1.7     | Updated Table 1–15 by adding Note (4).                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
| October 2012  | 1.6     | <ul style="list-style-type: none"> <li>■ Updated the maximum value for <math>V_I</math>, <math>V_{CCD\_PLL}</math>, <math>V_{CCIO}</math>, <math>V_{CC\_CLKIN}</math>, <math>V_{CCH\_GXB}</math>, and <math>V_{CCA\_GXB}</math> in Table 1–1.</li> <li>■ Updated Table 1–11 and Table 1–22.</li> <li>■ Updated Table 1–21 to include peak-to-peak differential input voltage for the Cyclone IV GX transceiver input reference clock.</li> <li>■ Updated Table 1–29 to include the typical <math>DCLK</math> value.</li> <li>■ Updated the minimum <math>f_{HCLK}</math> value in Table 1–31, Table 1–32, Table 1–33, Table 1–34, and Table 1–35.</li> </ul> |
| November 2011 | 1.5     | <ul style="list-style-type: none"> <li>■ Updated “Maximum Allowed Overshoot or Undershoot Voltage”, “Operating Conditions”, and “PLL Specifications” sections.</li> <li>■ Updated Table 1–2, Table 1–3, Table 1–4, Table 1–5, Table 1–8, Table 1–9, Table 1–15, Table 1–18, Table 1–19, and Table 1–21.</li> <li>■ Updated Figure 1–1.</li> </ul>                                                                                                                                                                                                                                                                                                            |
| December 2010 | 1.4     | <ul style="list-style-type: none"> <li>■ Updated for the Quartus II software version 10.1 release.</li> <li>■ Updated Table 1–21 and Table 1–25.</li> <li>■ Minor text edits.</li> </ul>                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |
| July 2010     | 1.3     | <p>Updated for the Quartus II software version 10.0 release:</p> <ul style="list-style-type: none"> <li>■ Updated Table 1–3, Table 1–4, Table 1–21, Table 1–25, Table 1–28, Table 1–30, Table 1–40, Table 1–41, Table 1–42, Table 1–43, Table 1–44, and Table 1–45.</li> <li>■ Updated Figure 1–2 and Figure 1–3.</li> <li>■ Removed SW Requirement and TCCS for Cyclone IV Devices tables.</li> <li>■ Minor text edits.</li> </ul>                                                                                                                                                                                                                          |
| March 2010    | 1.2     | <p>Updated to include automotive devices:</p> <ul style="list-style-type: none"> <li>■ Updated the “Operating Conditions” and “PLL Specifications” sections.</li> <li>■ Updated Table 1–1, Table 1–8, Table 1–9, Table 1–21, Table 1–26, Table 1–27, Table 1–31, Table 1–32, Table 1–33, Table 1–34, Table 1–35, Table 1–36, Table 1–37, Table 1–38, Table 1–40, Table 1–42, and Table 1–43.</li> <li>■ Added Table 1–5 to include ESD for Cyclone IV devices GPIOs and HSSI I/Os.</li> <li>■ Added Table 1–44 and Table 1–45 to include IOE programmable delay for Cyclone IV E 1.2 V core voltage devices.</li> <li>■ Minor text edits.</li> </ul>         |

